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(54) **ORGANIC LIGHT EMITTING DISPLAY DEVICE AND METHOD OF MANUFACTURING THE SAME**

ORGANISCHE LICHEMITTIERENDE ANZEIGEVORRICHTUNG UND VERFAHREN ZU DEREN HERSTELLUNG

DISPOSITIF D’AFFICHAGE ÉLECTROLUMINESCENT ORGANIQUE ET SON PROCÉDÉ DE FABRICATION

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**Description****CROSS-REFERENCE TO RELATED APPLICATIONS**

**[0001]** This application claims the benefit of the Korean Patent Application No. 10-2014-0123918 filed on September 17, 2014 and 10-2015-0109236 filed on July 31, 2015.

**BACKGROUND OF THE INVENTION****Field of the Invention**

**[0002]** The present invention relates to an organic light emitting display device, and more particularly, to an organic light emitting display device including a partition wall formed on a bank covering a portion of an auxiliary electrode and a method of manufacturing the same.

**Description of the Related Art**

**[0003]** As the times advance to the information-oriented society, flat panel display (FPD) which has good characteristics such as thinness, lightness, and low consumption power are increasing in importance. Examples of the FPD device includes liquid crystal display (LCD) device, plasma display panels (PDPs), organic light-emitting display device, etc. Recently, electrophoretic display (EPD) device is being widely used as one type of the FPD.

**[0004]** In particular, organic light emitting display device is self-emitting device and have low power consumption, a fast response time, high emission efficiency, high luminance, and a wide viewing angle in comparison with other display device. Therefore, the organic light emitting display device is attracting much attention as next-generation flat panel display.

**[0005]** FIG. 1 is a cross-sectional view illustrating a related art organic light emitting display device.

**[0006]** As illustrated in FIG. 1, the related art organic light emitting display device includes a substrate 10, a first electrode 11, an auxiliary electrode 15, a bank 20, an organic emission layer 12, a second electrode 13, an adhesive part 25, and a partition wall 30. The first electrode 11, the auxiliary electrode 15, and the bank 20 are formed on the substrate 10. The organic emission layer 12 is formed on the first electrode 11 and the bank 20. The second electrode 13 is formed on the organic emission layer 12. The adhesive part 25 is formed of the same material as that of the bank 20 and is disposed on a center portion of an upper surface of the auxiliary electrode 15. The partition wall 30 is formed on the adhesive part 25.

**[0007]** In this case, the organic emission layer 12 is divided into a plurality of parts respectively corresponding to a plurality of sub-pixels by the partition wall 30, and the second electrode (or a cathode) 13 is electrically connected to a partial region of the auxiliary electrode 15. In this case, the partial region of the auxiliary electrode 15 electrically connected to the cathode 13 may be changed

in each of the plurality of sub-pixels depending on a manufacturing process. Therefore, a difference occurs between voltages respectively supplied to the plurality of sub-pixels, causing a reduction in luminance uniformity of the organic light emitting display device. Also, in consideration of such characteristic, when a width of the auxiliary electrode 15 is broadened, a width of the first electrode (or an anode) 11 is reduced. For this reason, an aperture ratio of each of the plurality of sub-pixels is reduced, and moreover, the image quality and lifetime the organic light emitting display device are reduced.

**[0008]** US 2002/158835 A1 describes an organic EL display device having a first electrode, an auxiliary wiring element and a partition wall. The auxiliary wiring element is electrically insulated from the first electrode by the partition wall.

**[0009]** US 2011/037054 A1 describes an AMOLED having mushrooms structures. The mushrooms structures are formed surrounding and defining the limits of diodes.

**[0010]** US 2005/012454 A1 describes a light emitting device. A connection wiring and an auxiliary electrode are formed over a passivation film. Further, a second interlayer insulating film having openings for exposing a part of a pixel electrode and a part of the auxiliary electrode is formed over the passivation film.

**[0011]** US 2012/049207 A1 describes an organic light-emitting display. A spacer is disposed on a pixel defining layer in such a way that the spacer is tapered in a predetermined angle.

**[0012]** US 2012/205678 A1 describes a light-emitting device, wherein an insulating separation layer whose upper portion protrudes more than a bottom portion in a direction parallel to a substrate is provided on and in contact with a common wiring provided over the substrate.

**SUMMARY OF THE INVENTION**

**[0013]** Accordingly, the present invention is to provide an organic light emitting display device and a method of manufacturing the same that substantially obviate one or more problems due to limitations and disadvantages of the related art.

**[0014]** An object of the present invention is to provide an organic light emitting display device in which a partition wall is formed on a bank covering a portion of a first electrode and a portion of an auxiliary electrode, and thus, an aperture ratio, image quality, and lifetime are enhanced. The object is solved by the features of the independent claims.

**[0015]** In addition to the aforesaid objects of the present invention, other features and advantages of the present invention will be described below, but will be clearly understood by those skilled in the art from descriptions below.

**[0016]** Additional advantages and features of the invention will be set forth in part in the description which follows and in part will become apparent to those having

ordinary skill in the art upon examination of the following or may be learned from practice of the invention. The objectives and other advantages of the invention may be realized and attained by the structure particularly pointed out in the written description and claims hereof as well as the appended drawings.

**[0017]** The partition wall may comprise a reverse taper structure.

**[0018]** Also, the organic light emitting display device may comprise an organic emission layer on the first electrode; and a second electrode on the organic emission layer, wherein the organic emission layer is insulated from, by the partition wall, an organic emission layer included in an adjacent sub-pixel.

**[0019]** The organic emission layer may be disposed on the auxiliary electrode, and the organic emission layer is not disposed under the other portion except a portion of the bottom surface of the partition wall contacted the first bank.

**[0020]** A method of manufacturing an organic light emitting display device, the method may preferably comprise, forming an organic emission layer on the first electrode, the first bank, the partition wall, the auxiliary electrode, and the second bank; and forming a second electrode on the organic emission layer and a portion of the auxiliary electrode which is not covered by the organic emission layer.

**[0021]** In the forming of the first electrode and the auxiliary electrode, the first electrode and the auxiliary electrode may be formed of the same material on the same layer.

**[0022]** The forming of the partition wall may comprise coating partition wall materials on the first and second banks; irradiating light onto some materials of the partition wall materials located on a portion of a top surface of the first bank; removing some materials of the partition wall materials coated on a portion onto which the light is not irradiated; and curing some materials of the partition wall materials coated on a portion onto which the light is irradiated.

**[0023]** The partition wall materials may be negative type photoresists.

**[0024]** It is to be understood that both the foregoing general description and the following detailed description of the present invention are exemplary and explanatory and are intended to provide further explanation of the invention as claimed.

### **BRIEF DESCRIPTION OF THE DRAWINGS**

**[0025]** The accompanying drawings, which are included to provide a further understanding of the invention and are incorporated in and constitute a part of this application, illustrate embodiments of the invention and together with the description serve to explain the principle of the invention. In the drawings:

FIG. 1 is a cross-sectional view illustrating a related

art organic light emitting display device.

FIG. 2 is a plan view illustrating an organic light emitting display device according to an embodiment of the present invention.

FIG. 3 is a cross-sectional view illustrating in detail an organic light emitting display device according to an embodiment of the present invention.

FIGS. 4A to 4E are cross-sectional views for describing a method of manufacturing an organic light emitting display device according to an embodiment of the present invention.

### **DETAILED DESCRIPTION OF THE INVENTION**

**[0026]** Reference will now be made in detail to the exemplary embodiments of the present invention, examples of which are illustrated in the accompanying drawings. Wherever possible, the same reference numbers will be used throughout the drawings to refer to the same or like parts.

**[0027]** Advantages and features of the present invention, and implementation methods thereof will be clarified through following embodiments described with reference to the accompanying drawings. The present invention may, however, be embodied in different forms and should not be construed as limited to the embodiments set forth herein. Rather, these embodiments are provided so that this disclosure will be thorough and complete, and will fully convey the scope of the present invention to those skilled in the art. Furthermore, the present invention is only defined by the scope of the claims.

**[0028]** A shape, a size, a ratio, an angle, and a number disclosed in the drawings for describing embodiments of the present invention are merely an example, and thus, the present invention is not limited to the illustrated details. Like reference numerals refer to like elements throughout. In the following description, when the detailed description of the relevant known function or configuration is determined to unnecessarily obscure the important point of the present invention, the detailed description will be omitted. In a case where 'comprise', 'have', and 'include' described in the present specification are used, another part may be added unless 'only~' is used. The terms of a singular form may include plural forms unless referred to the contrary.

**[0029]** In construing an element, the element is construed as including an error range although there is no explicit description.

**[0030]** In describing a position relationship, for example, when a position relation between two parts is described as 'on~', 'over~', 'under~', and 'next~', one or more other parts may be disposed between the two parts unless 'just' or 'direct' is used.

**[0031]** In describing a time relationship, for example, when the temporal order is described as 'after~', 'subsequent~', 'next~', and 'before~', a case which is not continuous may be included unless 'just' or 'direct' is used.

**[0032]** It will be understood that, although the terms

"first", "second", etc. may be used herein to describe various elements, these elements should not be limited by these terms. These terms are only used to distinguish one element from another. For example, a first element could be termed a second element, and, similarly, a second element could be termed a first element, without departing from the scope of the present invention.

**[0033]** Features of various embodiments of the present invention may be partially or overall coupled to or combined with each other, and may be variously inter-operated with each other and driven technically as those skilled in the art can sufficiently understand. The embodiments of the present invention may be carried out independently from each other, or may be carried out together in co-dependent relationship.

**[0034]** Hereinafter, embodiments of the present invention will be described with reference to the accompanying drawings.

**[0035]** Hereafter whenever "may cover", "may include", "may be connected", "may be disposed" etc. is disclosed it should be understood as "covers", "includes", "is connected", "is disposed", etc.

**[0036]** FIG. 2 is a plan view illustrating an organic light emitting display device according to an embodiment of the present invention.

**[0037]** A display panel according to an embodiment of the present invention may be applied to the organic light emitting display device.

**[0038]** As illustrated in FIG. 2, the organic light emitting display device may include a display panel 100, a gate driver 200, a data driver 300, and a timing controller 400. The display panel 100 may include a plurality of sub-pixels P which are respectively provided in a plurality of areas defined by intersections of a plurality of gate lines GL1 to GLg and a plurality of data lines DL1 to DLd. In this case, the plurality of sub-pixels P may be defined by another means instead of the plurality of areas defined by intersections of the gate lines GL1 to GLg and the data lines DL1 to DLd. The gate driver 200 may supply a gate signal to the gate lines GL1 to GLg which are disposed in the display panel 100. The data driver 300 may respectively supply data signals to the data lines DL1 to DLd which are disposed in the display panel 100. The timing controller 400 may control a function of the gate driver 200 and a function of the data driver 300.

**[0039]** Each of the sub-pixels P may include an organic light emitting diode (OLED) emitting light and a driving circuit for driving the OLED.

**[0040]** The OLED may include an anode, an organic emission layer (or an organic compound layer), and a cathode. The anode may be connected to a transistor (TFT). A sealing part may be disposed on an upper end of the cathode.

**[0041]** The OLED may be implemented as a top emission type, where light emitted from the organic emission layer is irradiated in a direction from a lower substrate (or an array substrate) to an upper substrate, or a bottom emission type where the light emitted from the organic

emission layer is irradiated in a direction from the upper substrate to the lower substrate (or the array substrate). The OLED may emit light having certain luminance according to a current supplied from a driving transistor.

**[0042]** The anode of the OLED may be electrically connected to a first power source. The cathode may be connected to a second power source 500 through a below-described auxiliary electrode. In this case, the auxiliary electrode 150 may be electrically connected to a supply electrode 151 through a connection electrode disposed under the auxiliary electrode. Therefore, a plurality of supply electrodes 151 relevant to the sub-pixels P may be connected to the second power source 500 through a power supply line 155 in common.

**[0043]** The driving circuit may be electrically connected to a corresponding data line (hereinafter referred to as a data line) DL and a corresponding gate line (hereinafter referred to as a gate line) GL to control driving of the OLED. In this case, the driving circuit may include the driving transistor, a switching transistor, and a storage capacitor, but is not limited thereto. When the gate signal is supplied to the gate line GL, the driving circuit may control an amount of current supplied to the OLED according to a data signal supplied through the data line DL.

**[0044]** In this case, the driving transistor may be electrically connected between the first power source and the OLED. The switching transistor may be electrically connected to the driving transistor, the data line DL, and the gate line GL.

**[0045]** FIG. 3 is a cross-sectional view illustrating in detail an organic light emitting display device according to an embodiment of the present invention.

**[0046]** As illustrated in FIG. 3, the organic light emitting display device according to an embodiment of the present invention may include a driving transistor 120, a plurality of first electrodes 141 and 141', an auxiliary electrode 150, a first bank 161, a second bank 162, a partition wall 170, a plurality of organic emission layers 145 and 145', and a plurality of second electrodes 142 and 142'.

**[0047]** The driving transistor 120 may be disposed on a substrate 110. The first electrodes 141 and 141' may be electrically connected to the driving transistor 120. The auxiliary electrode 150 may be disposed on the same layer as the first electrodes 141 and 141' and may be disposed between the first electrodes 141 and 141' to be adjacent to the first electrodes 141 and 141'. The first bank 161 may cover a portion of the first electrode 141 and a portion of the auxiliary electrode 150. The second bank 162 may cover a portion of the first electrode 141' and another portion of the auxiliary electrode 150. The partition wall 170 may be disposed on the first bank 161. The organic emission layers 145 and 145' may be respectively disposed on the first electrodes 141 and 141'. The second electrode 142 may be disposed on the organic emission layers 145 and 145'.

**[0048]** The driving transistor 120 may be disposed on the substrate 110. The driving transistor 120 may include a gate electrode 123, a gate insulation layer 125, an ac-

tive layer 127, an interlayer dielectric 129, a first driving electrode 121, and a second driving electrode 122. In this case, the first driving electrode 121 may be a source electrode, and the second driving electrode 122 may be a drain electrode. In other embodiments, the first driving electrode 121 may be the drain electrode, and the second driving electrode 122 may be the source electrode.

**[0049]** The driving transistor 120 may be disposed in each of a plurality of sub-pixels on the substrate 110. A configuration of the driving transistor 120 is not limited to the above-described example and may be variously modified to be easily implemented by those skilled in the art.

**[0050]** A passivation layer 130 may be disposed on the driving transistor 120. The passivation layer 130 may include a contact hole 135. The first driving electrode 121 of the driving transistor 120 may be electrically connected to the first electrodes 141 and 141' through the contact hole 135.

**[0051]** The first electrodes 141 and 141' may be disposed on the passivation layer 130. The first electrodes 141 and 141' may be electrically connected to the first driving electrode 121 through the contact hole 135. The first electrodes 141 and 141' may be disposed in each of a plurality of sub-pixels. Each of the first electrodes 141 and 141' may act as an anode electrode or a cathode electrode depending on the type of the driving transistor 120. For example, the first electrodes 141 and 141' may respectively perform functions of anodes of a plurality of organic light emitting diodes (OLEDs) 140 and 140' and may each include a transparent conductive material having a large work function value. For example, each of the first electrodes 141 and 141' may be formed of indium tin oxide (ITO), indium zinc oxide (IZO), and/or the like. Also, the first electrodes 141 and 141' may each include a metal material which is good in reflection efficiency. For example, each of the first electrodes 141 and 141' may be formed of at least two or more layers including aluminum (Al), silver (Ag), Ag;Pb;Cu (APC), and/or the like.

**[0052]** The auxiliary electrode 150 may be disposed on the passivation layer 130. In this case, the auxiliary electrode 150 may be disposed between the first electrodes 141 and 141' to be adjacent to the first electrodes 141 and 141'. Therefore, the auxiliary electrode 150 may be disposed on the same layer to be spaced apart from the first electrodes 141 and 141'. The auxiliary electrode 150 may be formed simultaneously with the first electrodes 141 and 141'. In this case, the auxiliary electrode 150 and the first electrodes 141 and 141' may be formed of the same material. The auxiliary electrode 150 may be connected to, for example, a second power source through an auxiliary electrode line. Here, the second power source may be a ground electrode.

**[0053]** The first bank 161 may be disposed on the passivation layer 130. Also, the first bank 161 may be disposed between the first electrode 141 and the auxiliary electrode 150. In this case, the first bank 161 may cover

a portion of the first electrode 141 and a portion of the auxiliary electrode 150.

**[0054]** The second bank 162 may be disposed on the passivation layer 130. Also, the second bank 162 may be disposed between the first electrode 141' and the auxiliary electrode 150. In this case, the second bank 162 may cover another portion of the auxiliary electrode 150 which is opposite to the portion of the auxiliary electrode 150 covered by the first bank 161. Also, the second bank 162 may cover a portion of the first electrode 141' included in an adjacent sub-pixel.

**[0055]** The partition wall 170 may be disposed on the first bank 161. A portion (or a first portion) of a bottom of the partition wall 170 may contact a top surface of the first bank 161. Also, the other portion (or a second portion) except the portion of the bottom surface of the partition wall 170 may be disposed over the auxiliary electrode 150 to be spatially spaced apart from the auxiliary electrode 150. In this case, the other portion (or the second portion) except the portion (or the first portion) of the bottom surface of the partition wall 170 may not contact the top surface of the first bank 161. Therefore, the partition wall 170 may partially cover the top of the first bank 161. That is, the partition wall 170 may be disposed on one side of the top of the first bank 161. In this case, the one side of the top surface of the first bank 161 may be a portion (i.e., a direction looking at the auxiliary electrode 150 instead of a direction toward the first electrode 141) adjacent to the auxiliary electrode 150 with respect to a center line of the first bank 161. This is merely an embodiment, and in other embodiments, the partition wall 170 may be disposed on one side of a top surface of the second bank 162 instead of the top surface of the first bank 161. Here, the one side of the top surface of the second bank 162 may be a portion (i.e., a direction looking at the auxiliary electrode 150 instead of a direction toward the first electrode 141') adjacent to the auxiliary electrode 150 with respect to a center line of the second bank 162.

**[0056]** The partition wall 170 may be spaced apart from the second bank 162 by a certain width or more. The certain width may be, for example, 5  $\mu\text{m}$ . In this case, the partition wall 170 may not be disposed on the second bank 162. A portion of a top surface of the partition wall 170 may be disposed on the auxiliary electrode 150, but may not be disposed on the second bank 162. Therefore, an end of the top surface of the partition wall 170 in a direction toward the auxiliary electrode 150 may be spaced apart from, by a certain horizontal distance, an end of a bottom surface of the second bank 162 in a direction toward the auxiliary electrode 150. In this case, the certain horizontal distance may be a certain width. That is, the certain width may be a minimum distance from the partition wall 170 to the second bank 162. The partition wall 170 may be spaced apart from the second bank 162 by a certain width or more. Therefore, when the second electrode 142' is formed, the second electrode 142' may be connected to a connection portion A

of the auxiliary electrode 150 in each sub-pixel P. Here, the connection portion A may be a portion of the auxiliary electrode 150 which is not covered by the first and second banks 161 and 162.

**[0057]** Moreover, the second electrodes 142 and 142' may be connected to the auxiliary electrode 150 in each sub-pixel P, and thus, an auxiliary voltage may be applied to the second electrodes 142 and 142' of each sub-pixel P through the auxiliary electrode 150. Therefore, the luminance uniformity of an organic light emitting display device is enhanced.

**[0058]** Moreover, the partition wall 170 may be disposed on the first bank 161, and thus, a width of the auxiliary electrode 150 may be reduced by a width of a bottom surface of the partition wall 170. Therefore, a width of each of the first electrodes 141 and 141' disposed on the same layer may increase by a width of the auxiliary electrode 150. Accordingly, an opening width of the first electrode 141 may become broader. Therefore, an aperture ratio of each sub-pixel is enhanced. Also, as the aperture ratio is enhanced, the image quality and lifetime of an organic light emitting display device are enhanced.

**[0059]** The partition wall 170 may have a reverse taper structure where a width of a bottom surface of the partition wall 170 is narrower than that of a top surface of the partition wall 170. The reverse taper structure may be a structure where both side surfaces of the partition wall 170 are inclined to be symmetrical about a center line and the width of the bottom surface of the partition wall 170 is narrower than that of the top surface of the partition wall 170. Side surfaces of the partition wall 170 may include one or more inclined surfaces 170a, but the present embodiment is not limited thereto. In other embodiments, the side surfaces of the partition wall 170 may include two or more inclined surfaces.

**[0060]** The organic emission layers 145 and 145' may be formed all over the substrate 110. In this case, the organic emission layers 145 and 145' may be respectively disposed on the first electrodes 141 and 141'. The organic emission layers 145 and 145' may be disposed on the first electrode 141 which is not covered by the first bank 161 and the second bank 162. Also, the organic emission layers 145 and 145' may be disposed on the first bank 161 and the second bank 162. In this case, the organic emission layers 145 and 145' may cover a portion of a top surface of the first bank 161 and a whole top surface of the second bank 162. Also, the organic emission layers 145 and 145' may be disposed on the partition wall 170 and the auxiliary electrode 150. The organic emission layers 145 and 145' may be disposed all over the substrate 110 by evaporation. In this case, the partition wall 170 may block the deposited organic emission layers 145 and 145'. Therefore, the organic emission layers 145 and 145' may be disposed on the partition wall 170 and may not be disposed under a portion (or a second portion) of the bottom surface of the partition wall 170 which does not contact the first bank 161. Therefore, each of the organic emission layers 145 and 145' may

be divided into a plurality of parts respectively corresponding to the plurality of sub-pixels P by the partition wall 170 disposed on the first bank 161. Therefore, the organic emission layer 145 disposed in one sub-pixel P may be insulated from an organic emission layer 145' disposed in another adjacent sub-pixel P. Each of organic emission layers 145 and 145' may be formed to have a structure of a hole transport layer/emission layer/electron transport layer or a structure of a hole injection layer/hole transport layer/emission layer/electron transport layer/electron injection layer. Furthermore, each of organic emission layers 145 and 145' may further include a function layer for enhancing the emission efficiency and/or lifetime of the emission layer. In the structure of the organic emission layer, one or more layers may include a function of another layer. Therefore, one or more layers may be removed or added, and thus, the structure of each of organic emission layers 145 and 145' is not limited thereto.

**[0061]** The second electrodes 142 and 142' may be respectively formed all over the organic emission layers 145 and 145'. That is, the second electrodes 142 and 142' may be respectively disposed on the organic emission layers 145 and 145'. The second electrodes 142 and 142' may also be respectively disposed on the organic emission layers 145 and 145' covering the first and second banks 161 and 162. In this case, the second electrodes 142 and 142' may cover a portion of the top surface of the first bank 161 and the whole top surface of the second bank 162. Also, the second electrodes 142 and 142' may be disposed on the partition wall 170 and the auxiliary electrode 150. When the second electrodes 142 and 142' are deposited all over the substrate 110, the second electrodes 142 and 142' may be deposited through diffusion caused by plasma. Therefore, the second electrodes 142 and 142' may be deposited under the portion (or the second portion) of the bottom surface of the partition wall 170 which does not contact the first bank 161 blocked by the partition wall 170. Therefore, the second electrodes 142 and 142' may be disposed on a portion of the auxiliary electrode 150 which is not covered by the organic emission layers 145 and 145'. Therefore, the second electrodes 142 and 142' may be electrically connected to the auxiliary electrode 150. When the partition wall 170 is disposed on the first bank 161, for example, the second electrode 142' covering the whole top surface of the second bank 162 may be electrically connected to the auxiliary electrode 150. The second electrode 142 covering a portion of the top surface of the first bank 161 may not be electrically connected to the auxiliary electrode 150. Also, when the partition wall 170 is disposed on the second bank 162, for example, the second electrode 142 covering the whole top surface of the first bank 161 may be electrically connected to the auxiliary electrode 150. The second electrode 142' covering a portion of the top surface of the second bank 162 may not be electrically connected to the auxiliary electrode 150.

**[0062]** As described above, the partition wall 170 may be disposed on one of the first and second banks 161 and 162. Therefore, one of the second electrodes 142 and 142' may be electrically connected to the auxiliary electrode 150. That is, one of the second electrodes 142 and 142' next to both sides of the auxiliary electrode 150 may be electrically connected to the auxiliary electrode 150. Therefore, a width of the auxiliary electrode 150 may be more reduced than when all the second electrodes 142 and 142' next to the both sides of the auxiliary electrode 150 are electrically connected to the auxiliary electrode 150. A width of each of the first electrodes 141 and 141' disposed on the same layer as the auxiliary electrode 150 may increase to a degree to which a width of the auxiliary electrode 150 is reduced. Therefore, an opening width of each of the first electrodes 141 and 141' may become broader. Therefore, an aperture ratio of each sub-pixel is enhanced. Also, as the aperture ratio is enhanced, the image quality and lifetime of an organic light emitting display device are enhanced.

**[0063]** If each of the first electrodes 141 and 141' functions as an anode electrode, each of the second electrodes 142 and 142' may function as a cathode electrode. The second electrodes 142 and 142' may use a metal material which is very thin in thickness and is low in work function. For example, each of the second electrodes 142 and 142' may use a metal material such as Ag, Ti, Al, Mo, an alloy of Ag and Mg, and/or the like. In this case, each of the second electrodes 142 and 142' may be formed of the metal material to have a thickness (for example, 200  $\mu\text{m}$  or less) of hundreds  $\mu\text{m}$  or less. Therefore, each of the second electrodes 142 and 142' may be formed of a semi-transmissive layer and may be substantially used as a transparent cathode. However, the present embodiment is not limited thereto, and in other embodiments, each of the second electrodes 142 and 142' may use carbon nano tube, graphene, and/or the like. Also, in order to lower a resistance of each of the second electrodes 142 and 142', a material such as ITO, IZO, and/or the like having a high transmittance may be additionally deposited on each of the second electrodes 142 and 142'.

**[0064]** The OLED 140, as described above, may include the first electrodes 141 and 141', the organic emission layers 145 and 145', and the second electrodes 142 and 142'. Also, the OLED 140 may be disposed in each sub-pixel P and may emit light according to driving of the driving transistor 120.

**[0065]** FIGS. 4A to 4E are cross-sectional views for describing a method of manufacturing an organic light emitting display device according to an embodiment of the present invention. Particularly, FIGS. 4A to 4E illustrate respective cross-section views of a plurality of operations included in the method of manufacturing the organic light emitting display device according to an embodiment of the present invention.

**[0066]** First, as illustrated in FIG. 4A, the driving transistor 120 including the gate electrode 123, the gate in-

ulation layer 125, the active layer 127, the interlayer dielectric 129, the first driving electrode 121, and the second driving electrode 122 may be formed on the substrate 110.

**[0067]** The gate electrode 123 may be formed on the substrate 110. The gate electrode 123 may be formed of one of Mo, Al, Cr, Au, Ti, Ni, Nd, and Cu or an alloy thereof, but is not limited thereto. In other embodiments, the gate electrode 123 may be formed of various materials. Also, the gate electrode 123 may be formed of a single layer or a multilayer.

**[0068]** The gate insulation layer 125 may be formed on the gate electrode 123. The gate insulation layer 125 may insulate the gate electrode 123 from the active layer 127 which will be formed later. In this case, the gate insulation layer 125 may be formed of silicon oxide ( $\text{SiO}_x$ ), silicon nitride ( $\text{SiN}_x$ ), or a multilayer thereof, but is not limited thereto.

**[0069]** The active layer 127 may be formed on the gate insulation layer 125. The active layer 127 may be formed of amorphous silicon, polycrystalline silicon, an oxide semiconductor, and/or the like.

**[0070]** The interlayer dielectric 129 may be formed on the active layer 127. In this case, the interlayer dielectric 129 may be formed of the same material as that of the gate insulation layer 125, but is not limited thereto.

**[0071]** The first driving electrode 121 and the second driving electrode 122 may be formed on the interlayer dielectric 129. Each of the first driving electrode 121 and the second driving electrode 122 may be formed of one of Mo, Al, Cr, Au, Ti, Ni, Nd, and Cu or an alloy thereof, but is not limited thereto. In other embodiments, each of the first driving electrode 121 and the second driving electrode 122 may be formed of various materials. Also, each of the first driving electrode 121 and the second driving electrode 122 may be formed of a single layer or a multilayer.

**[0072]** The driving transistor 120 may be disposed in each of a plurality of sub-pixels on the substrate 110. A configuration of the driving transistor 120 is not limited to the above-described example and may be variously modified to be easily implemented by those skilled in the art.

**[0073]** Subsequently, as illustrated in FIG. 4B, the passivation layer 130, the first electrodes 141 and 141', and the auxiliary electrode 150 may be disposed on the driving transistor 120. The passivation layer 130 may be formed on the driving transistor 120. The passivation layer 130 may include the contact hole 135. In this case, the first driving electrode 121 of the driving transistor 120 may be connected to the first electrodes 141 and 141' through the contact hole 130. The passivation layer 130 may protect the driving transistor 120. The passivation layer 130 may be formed of, for example, one or more of polyacrylates resin, epoxy resin, phenolic resin, polyamides resin, polyimides resin, unsaturated polyesters resin, poly-phenylenethers resin, polyphenylenesulfides resin, benzocyclobutene, and/or the like, but is not limited

thereto.

**[0074]** The first electrodes 141 and 141' may be formed on the passivation layer 130. The first electrodes 141 and 141' may be formed to be electrically connected to the first driving electrode 121 through the contact hole 135. The first electrodes 141 and 141' may be formed in each of the plurality of sub-pixels in common and may be patterned through a photolithography process. Each of the first electrodes 141 and 141' may act as an anode electrode or a cathode electrode depending on the type of the driving transistor 120. For example, the first electrodes 141 and 141' may respectively perform functions of anodes of a plurality of organic light emitting diodes (OLEDs) 140 and 140' and may each include a transparent conductive material having a large work function value. For example, each of the first electrodes 141 and 141' may be formed of indium tin oxide (ITO), indium zinc oxide (IZO), and/or the like. Also, the first electrodes 141 and 141' may each include a metal material which is good in reflection efficiency. For example, each of the first electrodes 141 and 141' may be formed of at least two or more layers including aluminum (Al), silver (Ag), Ag;Pb;Cu (APC), and/or the like.

**[0075]** The auxiliary electrode 150 may be formed on the passivation layer 130. In this case, the auxiliary electrode 150 may be disposed between the first electrodes 141 and 141'. Therefore, the auxiliary electrode 150 may be formed on the same layer to be spaced apart from the first electrodes 141 and 141'. The auxiliary electrode 150 may be formed simultaneously with the first electrodes 141 and 141'. In this case, the auxiliary electrode 150 and the first electrodes 141 and 141' may be formed of the same material.

**[0076]** As illustrated in FIG. 4C, the first bank 161 and the second bank 162 may be formed on the passivation layer 130.

**[0077]** The first bank 161 may be formed on the passivation layer 130. Also, the first bank 161 may be formed between the first electrode 141 and the auxiliary electrode 150. In this case, the first bank 161 may cover a portion of the first electrode 141 and a portion of the auxiliary electrode 150.

**[0078]** The second bank 162 may be formed on the passivation layer 130. Also, the second bank 162 may be formed between the first electrode 141' and the auxiliary electrode 150. In this case, the second bank 162 may cover another portion of the auxiliary electrode 150 which is opposite to the portion of the auxiliary electrode 150 covered by the first bank 161. Also, the second bank 162 may cover a portion of the first electrode 141' included in an adjacent sub-pixel. In this case, each of the first and second banks 161 and 162 may be formed of an organic insulating material, for example, one of photo acryl, benzocyclobutene (BCB), etc., but is not limited thereto.

**[0079]** As illustrated in FIG. 4D, the partition wall 170 may be formed on the first bank 161.

**[0080]** The partition wall 170 may be formed on the

first bank 161. A portion (a first portion) of a bottom surface of the partition wall 170 may contact a top of the first bank 161. Also, the other portion (a second portion) except the portion of the bottom surface of the partition wall 170 may be formed over the auxiliary electrode 150 to be spatially spaced apart from the auxiliary electrode 150. In this case, the other portion (the second portion) except the portion (the first portion) of the bottom surface of the partition wall 170 may not contact the top surface of the first bank 161. Therefore, the partition wall 170 may partially cover the top surface of the first bank 161. That is, the partition wall 170 may be disposed on one side of the top surface of the first bank 161. In this case, the one side of the top surface of the first bank 161 may be a portion (i.e., a direction looking at the auxiliary electrode 150 instead of a direction toward the first electrode 141) adjacent to the auxiliary electrode 150 with respect to a center line of the first bank 161. This is merely an embodiment, and in other embodiments, the partition wall 170 may be formed on one side of a top surface of the second bank 162 instead of the top surface of the first bank 161. Here, the one side of the top surface of the second bank 162 may be a portion (i.e., a direction looking at the auxiliary electrode 150 instead of a direction toward the first electrode 141') adjacent to the auxiliary electrode 150 with respect to a center line of the second bank 162. Also, the partition wall 170 may be formed to be spaced apart from the second bank 162 by a certain width or more.

**[0081]** The partition wall 170 may have a reverse taper structure where a width of a bottom surface of the partition wall 170 is narrower than that of a top surface of the partition wall 170. The reverse taper structure may be a structure where both side surfaces of the partition wall 170 are inclined to be symmetrical about a center line and the width of the bottom surface of the partition wall 170 is narrower than that of the top of the partition wall 170. Side surfaces of the partition wall 170 may include one or more inclined surfaces 170a, but the present embodiment is not limited thereto. In other embodiments, the side surfaces of the partition wall 170 may include two or more inclined surfaces. In this case, the partition wall having the reverse taper structure may be formed of a negative type photoresist. The negative type photoresist may be a photosensitive material where a portion exposed to light is cured and thus is formed as a pattern, and a portion unexposed to the light is rinsed out by a solvent.

**[0082]** A process of forming the partition wall 170 may include: an operation of coating partition wall materials on the first and second banks 161 and 162; an operation of irradiating light onto some materials of the partition wall materials by using a patterned mask; an operation of removing some materials of the partition wall materials located on a portion onto which the light is not irradiated; and an operation of curing some materials of the partition wall materials remaining on a portion onto which the light is irradiated.

**[0083]** First, the partition wall materials may be coated on the first and second banks 161 and 162. The partition wall materials may use the negative type photoresist. The partition wall materials may be coated by a spin coating method. The spin coating method may be a coating method that drops a coating material onto a substrate and rotates the substrate at a high speed to thinly spread the coating material at a certain thickness, thereby coating the coating material on the substrate. However, the present embodiment is not limited thereto, and in other embodiments, the partition wall 170 may be formed by a roll coating method, a slit coating, and/or the like.

**[0084]** Subsequently, the light may be irradiated onto the partition wall materials by using the patterned mask. In this case, the patterned mask may be located on the partition wall materials. The light may be irradiated onto the partition wall materials through the mask. In this case, the mask may be located on the partition wall materials, and the light may be irradiated onto only the partition wall materials located on a portion of the top surface of the first bank 161 (or the second bank 162). Therefore, the light may not be irradiated onto the other portion where the partition wall is not formed.

**[0085]** Subsequently, some materials of the partition wall materials located on a portion onto which the light is not irradiated may be removed. Some materials of the partition wall materials coated on the portion onto which the light is not irradiated may be removed, and some materials of the partition wall materials coated on a portion onto which the light is irradiated may remain.

**[0086]** Finally, the partition wall 170 may be formed by curing some materials of the partition wall materials coated on the portion onto which the light is irradiated.

**[0087]** As described above, the partition wall 170 may be disposed on the top surface of the first bank 161. Thus, a width of the auxiliary electrode 150 may be reduced by a width of a bottom surface of the partition wall 170. Therefore, a width of each of the first electrodes 141 and 141' disposed on the same layer may increase by a width of the auxiliary electrode 150. Accordingly, an opening width of the first electrode 141 may become broader. Therefore, an aperture ratio of each sub-pixel is enhanced. Also, as the aperture ratio is enhanced, the image quality and lifetime of an organic light emitting display device are enhanced.

**[0088]** As illustrated in FIG. 4E, the organic emission layers 145 and 145' and the second electrodes 142 and 142' may be formed all over the substrate 110.

**[0089]** The organic emission layers 145 and 145' may be formed all over the substrate 110. In this case, the organic emission layers 145 and 145' may be respectively formed on the first electrodes 141 and 141'. The organic emission layers 145 and 145' may be formed on the first electrode 141 which is not covered by the first bank 161 and the second bank 162. Also, the organic emission layers 145 and 145' may be formed on the first bank 161 and the second bank 162. In this case, the organic emission layers 145 and 145' may cover a portion

of a top surface of the first bank 161 and a whole top surface of the second bank 162. Also, the organic emission layers 145 and 145' may be formed on the partition wall 170 and the auxiliary electrode 150. The organic emission layers 145 and 145' may be formed all over the substrate 110 by evaporation. In this case, the partition wall 170 may block the deposited organic emission layers 145 and 145'. Therefore, the organic emission layers 145 and 145' may be formed on the partition wall 170 and may not be formed under a portion (a second portion) of the bottom surface of the partition wall 170 which does not contact the first bank 161. Therefore, each of the organic emission layers 145 and 145' may be divided into a plurality of parts respectively corresponding to the plurality of sub-pixels P by the partition wall 170 formed on the first bank 161. Therefore, the organic emission layer 145 formed in one sub-pixel P may be insulated from an organic emission layer 145 formed in another adjacent sub-pixel P, and the organic emission layer 145' formed in one sub-pixel P may be insulated from an organic emission layer 145' formed in another adjacent sub-pixel P. Each of organic emission layers 145 and 145' may be formed to have a structure of a hole transport layer/emission layer/electron transport layer or a structure of a hole injection layer/hole transport layer/emission layer/electron transport layer/electron injection layer. Furthermore, each of organic emission layers 145 and 145' may further include a function layer for enhancing the emission efficiency and/or lifetime of the emission layer. In the structure of the organic emission layer, one or more layers may include a function of another layer. Therefore, one or more layers may be removed or added, and thus, the structure of each of organic emission layers 145 and 145' is not limited thereto.

**[0090]** The second electrodes 142 and 142' may be respectively formed all over the substrate 110 including the organic emission layers 145 and 145'. The second electrodes 142 and 142' may be respectively formed on the organic emission layers 145 and 145'. The second electrodes 142 and 142' may also be respectively formed on the organic emission layers 145 and 145' covering the first and second banks 161 and 162. In this case, the second electrodes 142 and 142' may cover a portion of the top surface of the first bank 161 and the whole top surface of the second bank 162. Also, the second electrodes 142 and 142' may be formed on the partition wall 170 and the auxiliary electrode 150. When the second electrodes 142 and 142' are deposited all over the substrate 110, the second electrodes 142 and 142' may be deposited through diffusion caused by plasma. Therefore, the second electrodes 142 and 142' may be deposited under the portion (the second portion) of the bottom surface of the partition wall 170 which does not contact the first bank 161 blocked by the partition wall 170. Therefore, the second electrodes 142 and 142' may be formed on a portion of the auxiliary electrode 150 which is not covered by the organic emission layers 145 and 145'. Therefore, the second electrodes 142 and 142' may be

electrically connected to the auxiliary electrode 150. When the partition wall 170 is formed on the first bank 161, for example, the second electrode 142' covering the whole top surface of the second bank 162 may be electrically connected to the auxiliary electrode 150.

**[0091]** If each of the first electrodes 141 and 141' functions as an anode electrode, each of the second electrodes 142 and 142' may function as a cathode electrode. The second electrodes 142 and 142' may use a metal material which is very thin in thickness and is low in work function. For example, each of the second electrodes 142 and 142' may use a metal material such as Ag, Ti, Al, Mo, an alloy of Ag and Mg, and/or the like. In this case, each of the second electrodes 142 and 142' may be formed of the metal material to have a thickness (for example, 200  $\mu\text{m}$  or less) of hundreds  $\mu\text{m}$  or less. Therefore, each of the second electrodes 142 and 142' may be formed of a semi-transmissive layer and may be substantially used as a transparent cathode. However, the present embodiment is not limited thereto, and in other embodiments, each of the second electrodes 142 and 142' may use carbon nano tube, graphene, and/or the like. Also, in order to lower a resistance of each of the second electrodes 142 and 142', a material such as ITO, IZO, and/or the like having a high transmittance may be additionally deposited on each of the second electrodes 142 and 142'.

**[0092]** The OLED 140, as described above, may include the first electrode 141, the organic emission layer 145, and the second electrode 142. Also, the OLED 140 may be disposed in each sub-pixel P and may emit light according to driving of the driving transistor 120.

**[0093]** Moreover, although not shown in the drawing, the sealing part may be formed on the substrate 110 that includes the OLED 140 and the driving transistor 120. The sealing part protects the elements, such as the OLED 140, the driving transistor 120, etc., from an external impact and prevents the penetration of water.

**[0094]** According to the embodiments of the present invention, a thin film transistor (TFT) may be applied to a top gate structure and a bottom gate structure.

**[0095]** As described above, according to the embodiments of the present invention, since the partition wall is formed on the bank, each of the plurality of pixel areas increases, and an aperture ratio is enhanced.

**[0096]** Moreover, according to the embodiments of the present invention, the luminance uniformity and image quality of an organic light emitting display device are enhanced.

**[0097]** It will be apparent to those skilled in the art that various modifications and variations can be made in the present invention without departing from the scope of the invention which is defined in the appended claims.

## Claims

1. An organic light emitting display device comprising:

a first electrode (141) connected to a driving transistor (120);

an auxiliary electrode (150) on the same layer (130) as the first electrode (141);

a first bank (161) configured to cover one end of the first electrode (141) and to cover one end of the auxiliary electrode (150); **characterised**

**in that:**

a partition wall (170) is disposed on the first bank (161), the partition wall having a bottom surface comprising a first portion adjacent the first electrode (141) and a second portion adjacent the auxiliary electrode (150), wherein said first portion contacts only one side of the top surface of the first bank (161) and wherein said second portion does not contact the top surface of the first bank (161), such that the partition wall (170) only partially covers the top surface of the first bank (161), wherein said second portion is disposed over the auxiliary electrode (150) to be spatially spaced apart from the auxiliary electrode (150) to have a gap therebetween.

2. The organic light emitting display device of claim 1, further comprising a second bank (162) configured to cover an opposing end of the auxiliary electrode (150), wherein the second bank (162) is spaced apart from the partition wall (170) by a certain width, and the partition wall (170) is not disposed on the second bank (162).
3. The organic light emitting display device of claim 2, further comprising:

an organic emission layer (145) on the first electrode (141) and a second electrode (142) on the organic emission layer (145);

wherein the organic emission layer (145) also covers a portion of the top surface of the first bank (161) and a whole top of the second bank (162), and

wherein the organic emission layer (145) extends onto a portion of the auxiliary electrode (150) but does not extend into the gap between the second portion of the bottom surface of the first bank (161) and the auxiliary electrode (150).

4. The organic light emitting display device of claim 3, wherein the partition wall (170) comprises a reverse taper structure.
5. The organic light emitting display device of claim 4, wherein the organic emission layer (145) is insulated from the organic emission layer included in an adjacent sub-pixel by the partition wall (170).
6. The organic light emitting display device of claim 5, wherein the second electrode (142) also covers the

organic emission layer (145) over the first portion of the top surface of the first bank (161), the whole top of the second bank (162), to extend onto the portion of the auxiliary electrode (150) and extending into the gap between the second portion of the bottom surface of the first bank (161) and the auxiliary electrode (150) to contact the auxiliary electrode (150).

7. A method of manufacturing the organic light emitting display device of claim 1, the method comprising:

forming the first electrode (141) connected to the driving transistor (120) and forming the auxiliary electrode (150) spaced apart from the first electrode (141);

forming the first bank (161), which covers one end of the first electrode (141) and one end of the auxiliary electrode (150), and a second bank (162) that covers an opposite end of the auxiliary electrode (150); and

forming the partition wall (170) on the first bank (161).

8. The method of claim 7, further comprising:

forming an organic emission layer (145) on the first electrode (141), the first bank (161), the partition wall (170), the auxiliary electrode (150), and the second bank (162); and

forming a second electrode (142) on the organic emission layer (145) and extending into said gap on a portion of the auxiliary electrode (150) which is not covered by the organic emission layer (145).

9. The method of claim 7 or 8, wherein in the forming of the first electrode (141) and the auxiliary electrode (150), the first electrode (141) and the auxiliary electrode (150) are formed of the same material on the same layer (130).

10. The method of any one of the claims 7 to 9, wherein the forming of the partition wall (170) comprises:

coating partition wall materials on the first and second banks (161, 162);

irradiating light onto some materials of the partition wall materials located on the top surface of the first bank (161);

removing some materials of the partition wall materials coated on a portion onto which the light is not irradiated; and

curing some materials of the partition wall materials coated on a portion onto which the light is irradiated.

11. The method of claim 10, wherein the partition wall materials are negative type photoresists.

## Patentansprüche

1. Organische Licht emittierende Anzeigevorrichtung, umfassend:

eine erste Elektrode (141), die mit einem Treibertransistor (120) verbunden ist;

eine Hilfselektrode (150) auf der gleichen Schicht (130) wie die erste Elektrode (141);

eine erste Leiste (161), die konfiguriert ist, um ein Ende der ersten Elektrode (141) abzudecken und ein Ende der Hilfselektrode (150) abzudecken;

**dadurch gekennzeichnet, dass:**

eine Trennwand (170) auf der ersten Leiste (161) angeordnet ist, wobei die Trennwand eine untere Oberfläche aufweist, die einen ersten Abschnitt neben der ersten Elektrode (141) und einen zweiten Abschnitt neben der Hilfselektrode (150) umfasst, wobei der erste Abschnitt nur eine Seite der oberen Oberfläche der ersten Leiste (161) kontaktiert, und wobei der zweite Abschnitt die obere Oberfläche der ersten Leiste (161) nicht kontaktiert, so dass die Trennwand (170) die obere Oberfläche der ersten Leiste (161) nur teilweise abdeckt, wobei der zweite Abschnitt über der Hilfselektrode (150) angeordnet ist, um von der Hilfselektrode (150) räumlich beabstandet zu sein, um einen Zwischenraum dazwischen aufzuweisen.

2. Organische Licht emittierende Anzeigevorrichtung nach Anspruch 1, ferner umfassend eine zweite Leiste (162), die konfiguriert ist, um ein gegenüberliegendes Ende der Hilfselektrode (150) abzudecken, wobei die zweite Leiste (162) von der Trennwand (170) um eine gewisse Breite beabstandet ist, und die Trennwand (170) nicht auf der zweiten Leiste (162) angeordnet ist.

3. Organische Licht emittierende Anzeigevorrichtung nach Anspruch 2, ferner umfassend:

eine organische Emissionsschicht (145) auf der ersten Elektrode (141) und eine zweite Elektrode (142) auf der organischen Emissionsschicht (145);

wobei die organische Emissionsschicht (145) auch einen Abschnitt der oberen Oberfläche der ersten Leiste (161) und einen gesamten oberen Teil der zweiten Leiste (162) abdeckt, und

wobei sich die organische Emissionsschicht (145) auf einen Abschnitt der Hilfselektrode (150) erstreckt, sich jedoch nicht in den Zwischenraum zwischen dem zweiten Abschnitt der unteren Oberfläche der ersten Leiste (161) und der Hilfselektrode (150) erstreckt.

4. Organische Licht emittierende Anzeigevorrichtung nach Anspruch 3, wobei die Trennwand (170) eine umgekehrt verjüngte Struktur umfasst.
5. Organische Licht emittierende Anzeigevorrichtung nach Anspruch 4, wobei die organische Emissionsschicht (145) gegenüber der organischen Emissionsschicht, die in einem angrenzenden Unterpixel enthalten ist, durch die Trennwand (170) isoliert ist.
6. Organische Licht emittierende Anzeigevorrichtung nach Anspruch 5, wobei die zweite Elektrode (142) auch die organische Emissionsschicht (145) über dem ersten Abschnitt der oberen Oberfläche der ersten Leiste (161), den gesamten oberen Teil der zweiten Leiste (162) abdeckt, um sich auf den Abschnitt der Hilfselektrode (150) zu erstrecken, und sich in den Zwischenraum zwischen dem zweiten Abschnitt der unteren Oberfläche der ersten Leiste (161) und der Hilfselektrode (150) erstreckt, um die Hilfselektrode (150) zu kontaktieren.
7. Verfahren zum Herstellen der organischen Licht emittierenden Anzeigevorrichtung nach Anspruch 1, wobei das Verfahren folgende Schritte umfasst:
- Bilden der ersten Elektrode (141), die mit dem Treibertransistor (120) verbunden ist, und Bilden der Hilfselektrode (150), die von der ersten Elektrode (141) beabstandet ist;
- Bilden der ersten Leiste (161), die ein Ende der ersten Elektrode (141) und ein Ende der Hilfselektrode (150) abdeckt, und einer zweiten Leiste (162), die ein gegenüberliegendes Ende der Hilfselektrode (150) abdeckt; und
- Bilden der Trennwand (170) auf der ersten Leiste (161).
8. Verfahren nach Anspruch 7, ferner umfassend folgende Schritte:
- Bilden einer organischen Emissionsschicht (145) auf der ersten Elektrode (141), der ersten Leiste (161), der Trennwand (170), der Hilfselektrode (150) und der zweiten Leiste (162); und
- Bilden einer zweiten Elektrode (142) auf der organischen Emissionsschicht (145) und Verlängern in den Zwischenraum auf einem Abschnitt der Hilfselektrode (150), der nicht durch die organische Emissionsschicht (145) abgedeckt ist.
9. Verfahren nach Anspruch 7 oder 8, wobei bei dem Bilden der ersten Elektrode (141) und der Hilfselektrode (150) die erste Elektrode (141) und die Hilfselektrode (150) aus dem gleichen Werkstoff auf der gleichen Schicht (130) gebildet werden.
10. Verfahren nach einem der Ansprüche 7 bis 9, wobei

das Bilden der Trennwand (170) Folgendes umfasst:

Auftragen von Trennwandwerkstoffen auf die ersten und zweiten Leisten (161, 162);

Strahlen von Licht auf einige Werkstoffe der Trennwandwerkstoffe, die sich auf der oberen Oberfläche der ersten Leiste (161) befinden;

Entfernen einiger Werkstoffe der Trennwandwerkstoffe, die auf einen Abschnitt aufgetragen wurden, auf den das Licht nicht gestrahlt wird; und

Aushärten einiger Werkstoffe der Trennwandwerkstoffe, die auf einen Abschnitt aufgetragen wurden, auf den Licht gestrahlt wird.

11. Verfahren nach Anspruch 10, wobei die Trennwandwerkstoffe Photoresists negativer Art sind.

## Revendications

1. Dispositif d'affichage à émission de lumière organique comprenant :

une première électrode (41) connectée à un transistor de pilotage (120) ;

une électrode auxiliaire (150) sur la même couche (130) que la première électrode (141) ;

un premier banc (161) configuré pour recouvrir une extrémité de la première électrode (141) et pour recouvrir une extrémité de l'électrode auxiliaire (150) ; **caractérisé par le fait que** :

une paroi de séparation (170) est disposée sur le premier banc (161), la paroi de séparation présentant une surface inférieure comprenant une première partie adjacente à la première électrode (141) et une seconde partie adjacente à l'électrode auxiliaire (150), ladite première partie étant en contact uniquement avec un côté de la surface supérieure du premier banc (161) et ladite seconde partie n'étant pas en contact avec la surface supérieure du premier banc (161), de telle sorte que la paroi de séparation (170) recouvre uniquement partiellement la surface supérieure du premier banc (161), ladite seconde partie étant disposée sur l'électrode auxiliaire (150) pour être spatialement espacée de l'électrode auxiliaire (150) afin d'avoir un espace entre celles-ci.

2. Dispositif d'affichage à émission de lumière organique selon la revendication 1, comprenant en outre un second banc (162) configuré pour recouvrir une extrémité opposée de l'électrode auxiliaire (150), le second banc (162) étant espacé de la paroi de séparation (170) d'une certaine largeur, et la paroi de séparation (170) n'étant pas disposée sur le second banc (162).

3. Dispositif d'affichage à émission de lumière organique selon la revendication 2, comprenant en outre :

une couche d'émission organique (145) sur la première électrode (141) et une seconde électrode (142) sur la couche d'émission organique (145) ;

dans lequel la couche d'émission organique (145) recouvre également une partie de la surface supérieure du premier banc (161) et toute la partie supérieure du second banc (162), et dans lequel la couche d'émission organique (145) s'étend sur une partie de l'électrode auxiliaire (150) mais ne s'étend pas dans l'espace entre la seconde partie de la surface inférieure du premier banc (161) et l'électrode auxiliaire (150).

4. Dispositif d'affichage à émission de lumière organique selon la revendication 3, dans lequel la paroi de séparation (170) comprend une structure conique inverse.

5. Dispositif d'affichage à émission de lumière organique selon la revendication 4, dans lequel la couche d'émission organique (145) est isolée vis-à-vis de la couche d'émission organique comprise dans un sous-pixel adjacent par la paroi de séparation (170).

6. Dispositif d'affichage à émission de lumière organique selon la revendication 5, dans lequel la seconde électrode (142) recouvre également la couche d'émission organique (145) sur la première partie de la surface supérieure du premier banc (161), toute la partie supérieure du second banc (162), pour s'étendre sur la partie de l'électrode auxiliaire (150) et s'étendant dans l'espace entre la seconde partie de la surface inférieure du premier banc (161) et électrode auxiliaire (150) pour être en contact avec l'électrode auxiliaire (150).

7. Procédé de fabrication du dispositif d'affichage à émission de lumière organique selon la revendication 1, le procédé comprenant :

former la première électrode (141) connectée au transistor de pilotage (120) et former l'électrode auxiliaire (150) espacée de la première électrode (141) ;

former le premier banc (161), qui recouvre une extrémité de la première électrode (141) et une extrémité de l'électrode auxiliaire (150), et un second banc (162) qui recouvre une extrémité opposée de l'électrode auxiliaire (150) ; et

former la paroi de séparation (170) sur le premier banc (161).

8. Procédé selon la revendication 7, comprenant en

outre :

former une couche d'émission organique (145) sur la première électrode (141), le premier banc (161), la paroi de séparation (170), l'électrode auxiliaire (150) et le second banc (162) ; et former une seconde électrode (142) sur la couche d'émission organique (145) et s'étendant dans ledit espace sur une partie de l'électrode auxiliaire (150) qui n'est pas recouverte par la couche d'émission organique (145).

9. Procédé selon la revendication 7 ou 8, dans lequel, lors de la formation de la première électrode (141) et de l'électrode auxiliaire (150), la première électrode (141) et l'électrode auxiliaire (150) sont formées du même matériau sur la même couche (130).

10. Procédé selon l'une quelconque des revendications 7 à 9, dans lequel la formation de la paroi de séparation (170) comprend :

appliquer en revêtement des matériaux de paroi de séparation sur les premier et second bancs (161, 162) ;

émettre une lumière sur certains matériaux parmi les matériaux de paroi de séparation situés sur la surface supérieure du premier banc (161) ;

retirer certains matériaux parmi les matériaux de paroi de séparation appliqués en revêtement sur une partie sur laquelle la lumière n'est pas émise ; et

durcir certains matériaux parmi les matériaux de paroi de séparation appliqués en revêtement sur une partie sur laquelle la lumière est émise.

11. Procédé selon la revendication 10, dans lequel les matériaux de paroi de séparation sont des résines photosensibles de type négatives.

FIG. 1  
(RELATED ART)

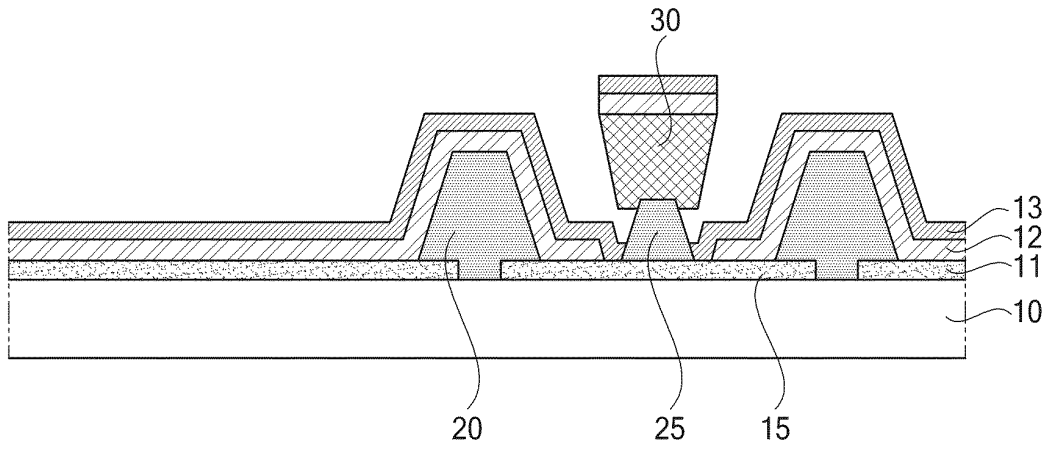


FIG. 2

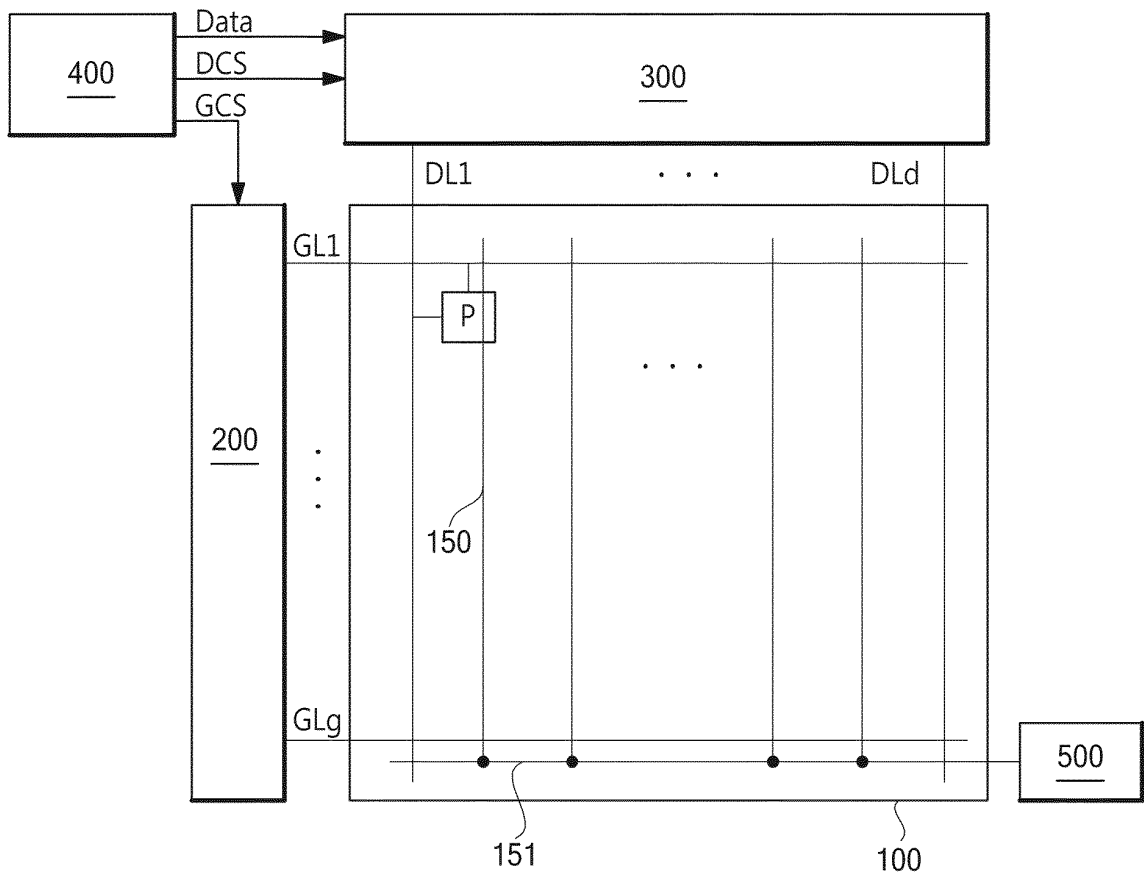


FIG. 3

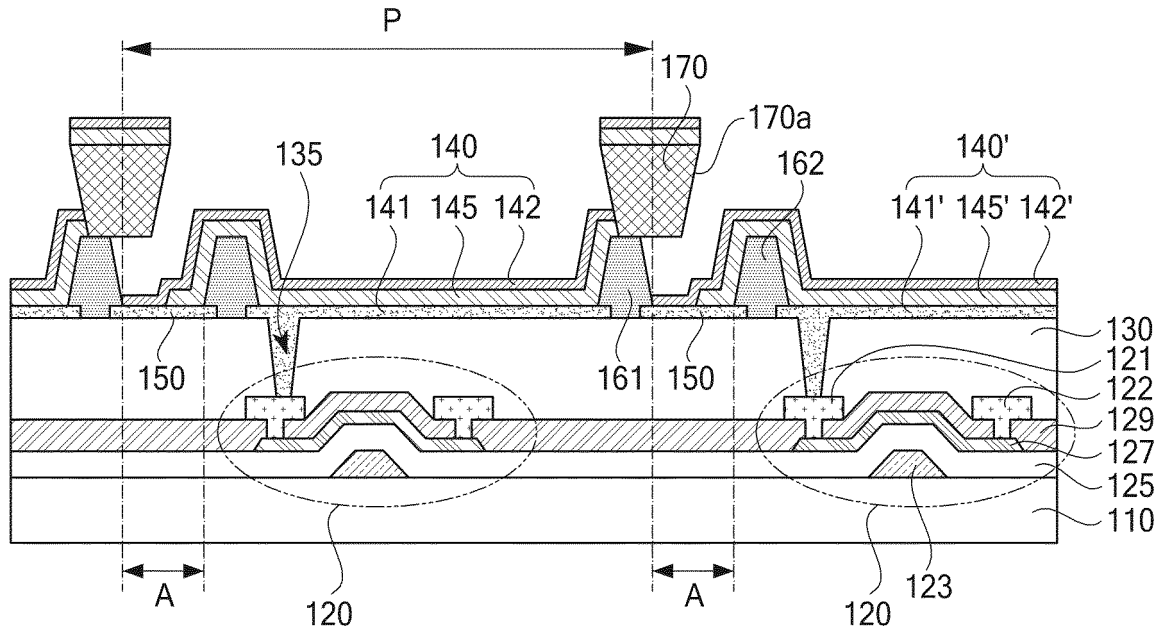


FIG. 4A

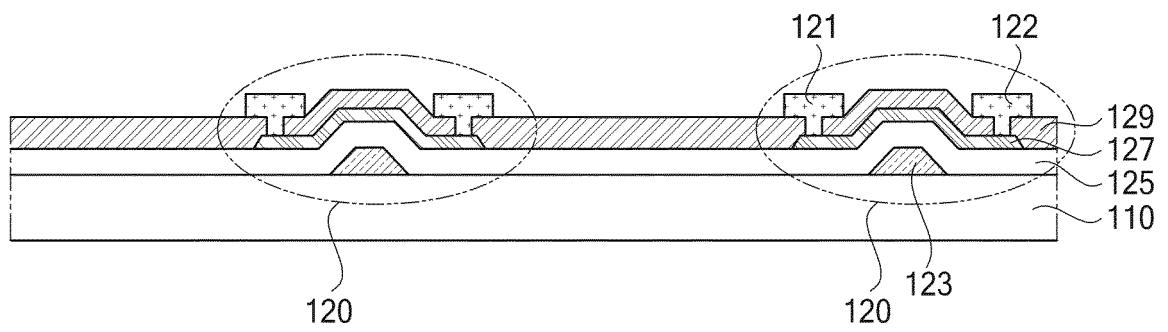


FIG. 4B

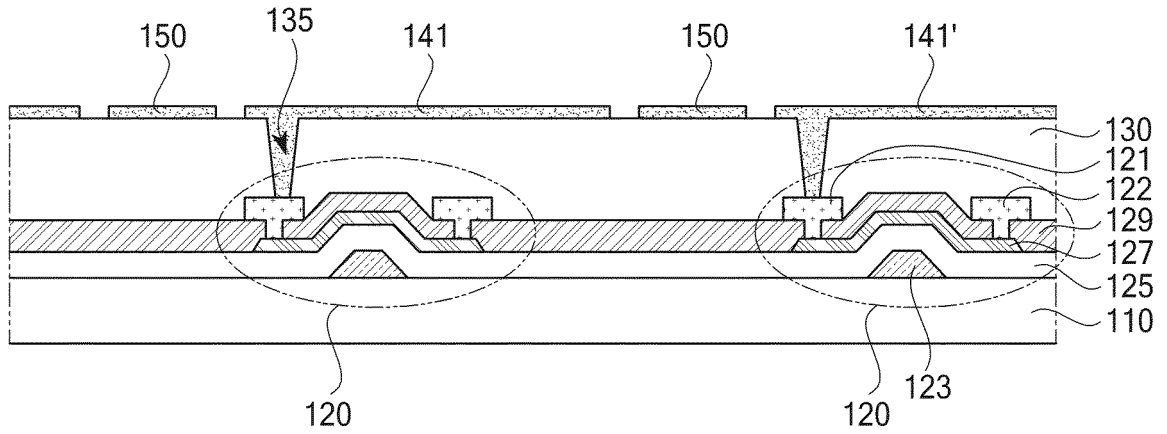


FIG. 4C

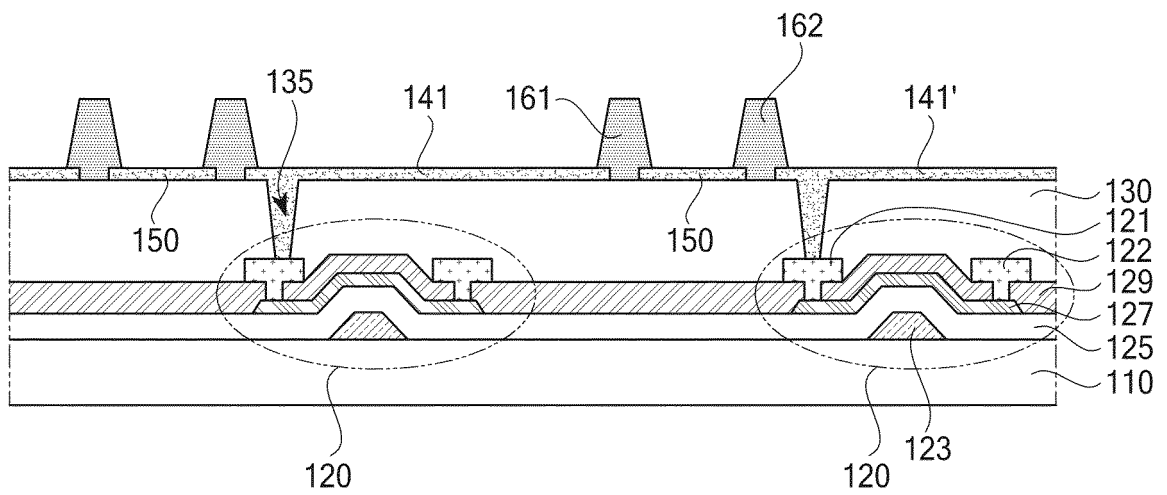


FIG. 4D

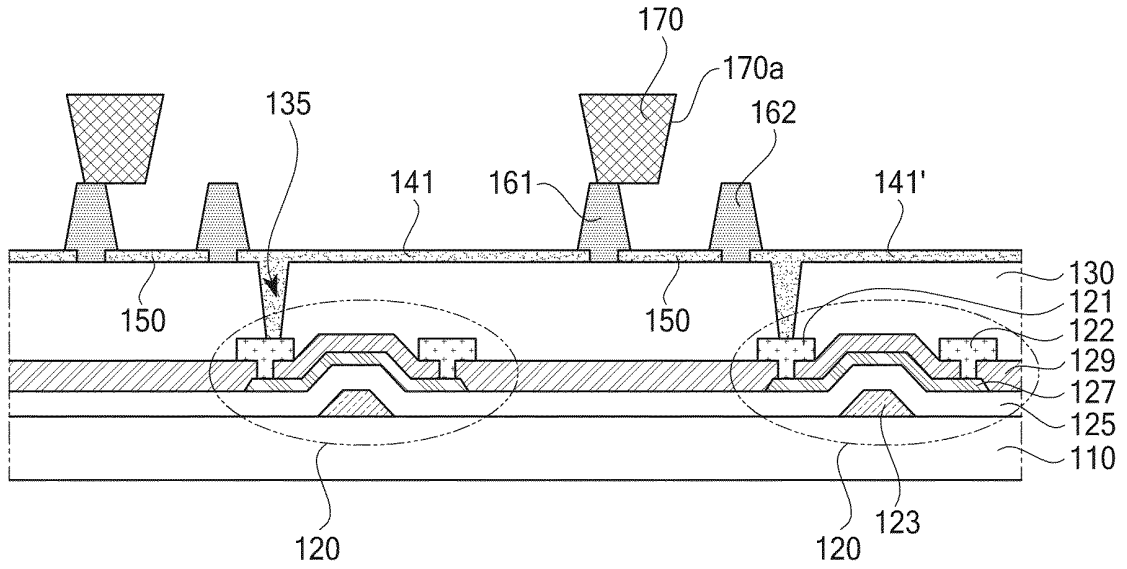
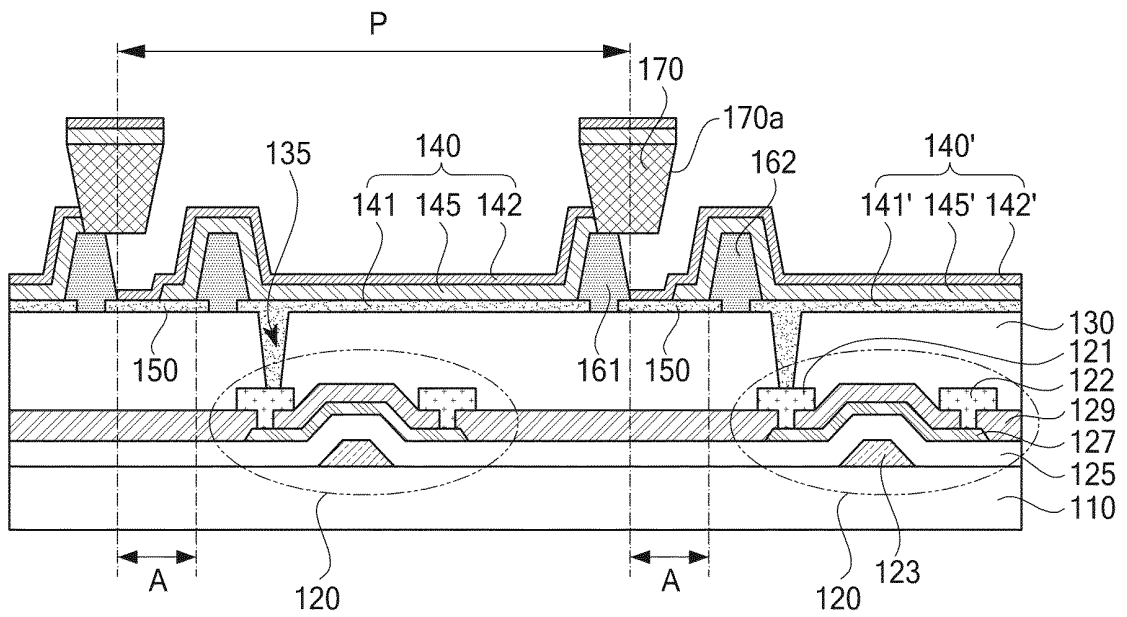


FIG. 4E



**REFERENCES CITED IN THE DESCRIPTION**

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专利名称(译)	有机发光显示装置及其制造方法		
公开(公告)号	<a href="#">EP2998997B1</a>	公开(公告)日	2020-01-08
申请号	EP2015185391	申请日	2015-09-16
[标]申请(专利权)人(译)	乐金显示有限公司		
申请(专利权)人(译)	LG DISPLAY CO., LTD.		
当前申请(专利权)人(译)	LG DISPLAY CO., LTD.		
[标]发明人	LEE JOON SUK LEE JAE SUNG		
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IPC分类号	H01L27/32		
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优先权	1020140123918 2014-09-17 KR 1020150109236 2015-07-31 KR		
其他公开文献	EP2998997A1		
外部链接	<a href="#">Espacenet</a>		

摘要(译)

公开了一种有机发光显示装置，其中，在覆盖辅助电极（150）的一部分的堤（161）上形成有隔壁（170），从而提高了开口率。有机发光显示装置包括第一电极（141），辅助电极（150），第一堤（161）和分隔壁（170）。第一电极（141）可以连接到驱动晶体管（120），辅助电极（150）可以设置在与第一电极（141）相同的层（1309）上，第一堤坝（161）可以覆盖第一电极（141）。第一电极141的一部分和辅助电极150的一部分，隔壁170的底面的一部分可以与第一堤坝161的顶面接触，而另一部分除外。底表面的一部分可以设置在辅助电极（150）上。

FIG. 1  
(RELATED ART)

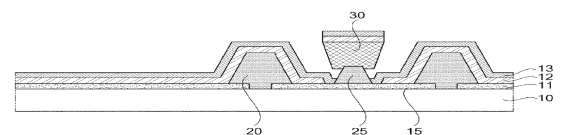


FIG. 2

